TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (U-MOSVI-H)

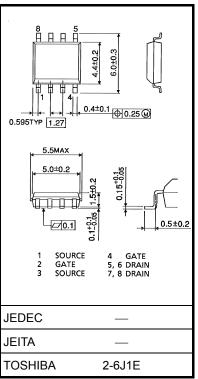
# TPC8216-H

High Efficiency DC-DC Converter Applications Notebook PC Applications Portable-Equipment Applications

- Small footprint due to a small and thin package
- High-speed switching
- Small gate charge: Q<sub>SW</sub> = 3.4 nC (typ.)
- Low drain-source ON-resistance:  $R_{DS(ON)} = 13.6 \text{ m}\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 19 \text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 30 \ V)$
- Enhancement mode:  $V_{th}$  = 1.3 to 2.3 V ( $V_{DS}$  = 10 V,  $I_D$  = 0.1 mA)

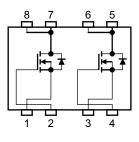
### Absolute Maximum Ratings (Ta = 25°C)

Cha	racteristic	Symbol	Rating	Unit		
Drain-source vo	Itage	V <sub>DSS</sub>	30	V		
Drain-gate volta	ge (R <sub>GS</sub> = 20 kΩ)	V <sub>DGR</sub>	V <sub>DGR</sub> 30			
Gate-source vol	tage	V <sub>GSS</sub>	±20	V		
Dualia aurorat	D C (Note 1)	ID	6.4	А		
Drain current	Pulse (Note 1)	I <sub>DP</sub>	25.6	A		
Drain power dissipation	Single-device operation (Note 3a)	P <sub>D (1)</sub>	1.5			
(t = 10 s) (Note 2a)	operation (Note 3a)     PD (1)     1.3       Single-device value at dual operation (Note 3b)     PD (2)     1.1       Single-device operation (Note 3a)     PD (1)     0.75	W				
Irain nower	Single-device operation (Note 3a)	P <sub>D (1)</sub>	0.75			
(t = 10 s) (Note 2b)	Single-device value at dual operation (Note 3b)	P <sub>D 2)</sub>	0.45	W		
Single-pulse ava	lanche energy (Note 4)	E <sub>AS</sub>	53	mJ		
Avalanche curre	nt	I <sub>AR</sub>	6.4	А		
Repetitive avalar (Note	nche energy e 2a, Note 3b, Note 5)	E <sub>AR</sub>	0.13	mJ		
Channel tempera	ature	T <sub>ch</sub>	150	°C		
Storage tempera	ture range	T <sub>stg</sub>	–55 to 150	°C		



Weight: 0.085 g (typ.)

## **Circuit Configuration**



Note: For Notes 1 to 4, refer to the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating" Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

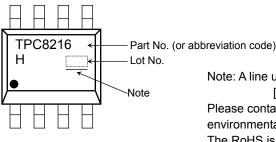
This transistor is an electrostatic-sensitive device. Handle with care.

Unit: mm

## **Thermal Characteristics**

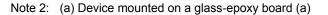
Characteristic	Symbol	Max	Unit		
Thermal resistance, channel to ambient	Single-device operation (Note 3a)	R <sub>th (ch-a)</sub> (1)	83.3	°C/W	
(t = 10 s) (Note 2a)	Single-device value at dual operation (Note 3b)	ual operation R <sub>th (ch-a) (2)</sub> 114	114		
Thermal resistance, channel to ambient	Single-device operation (Note 3a)	R <sub>th (ch-a)</sub> (1)	167	-	
(t = 10 s) (Note 2b)	Single-device value at dual operation (Note 3b)	R <sub>th (ch-a) (2)</sub>	278		

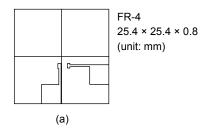
#### Marking



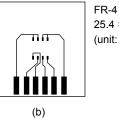
Note: A line under a Lot No. identifies the indication of product Labels. [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]] Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Note 1: Ensure that the channel temperature does not exceed 150°C.





(b) Device mounted on a glass-epoxy board (b)



25.4 × 25.4 × 0.8 (unit: mm)

Note 3:

- a) The power dissipation and thermal resistance values are shown for a single device (During single-device operation, power is only applied to one device.)
- b) The power dissipation and thermal resistance values are shown for a single device (During dual operation, power is evenly applied to both devices.)

Note 4:  $V_{DD}$  = 24 V,  $T_{ch}$  = 25°C (Initial), L = 1.0 mH, R<sub>G</sub> = 25  $\Omega$ , I<sub>AR</sub> = 6.4 A

- Note 5: Repetitive rating: pulse width limited by maximum channel temperature
- Note 6: on the lower left of the marking indicates Pin 1.
  - \* Weekly code: (three digits)



Week of manufacture (01 for the first week of the year, continuing up to 52 or 53)

Year of manufacture (the last digit of the year)

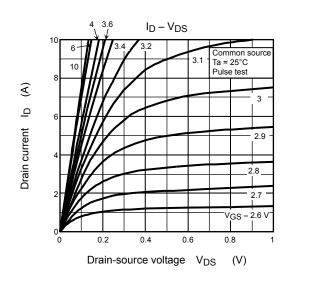
Electrical Characteristics (Ta = 25°C)

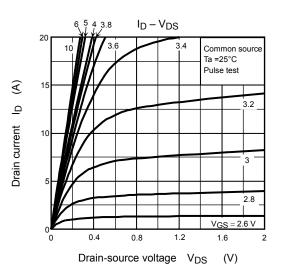
Chara	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I <sub>GSS</sub>	$V_{GS}=\pm 20~V,~V_{DS}=0~V$			±100	nA
Drain cutoff curr	rent	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	—	—	10	μA
Drain agurag br	burce breakdown voltage				V		
Dialit-Source bit	eakuown vollage	V (BR) DSX	$I_D = 10 \text{ mA}, \text{ V}_{GS} = -20 \text{ V}$	15	_	_	
Gate threshold v	voltage	V <sub>th</sub>	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 0.1 \text{ mA}$	1.3	_	2.3	V
Drain course ON	l registance	R <sub>DS (ON)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_D = 3.2 \text{ A}$		16.5	23.0	mΩ
Drain-Source Or	N-TESISIATICE	R <sub>DS (ON)</sub>	$V_{GS} = 10 \text{ V}$ , $I_D = 3.2 \text{ A}$	—         13.6         20.0           9.5         19         —		20.0	
Forward transfe	r admittance	Y <sub>fs</sub>	$V_{DS} = 10 \text{ V}$ , $I_D = 3.2 \text{ A}$	9.5	19		S
Input capacitance	ce	C <sub>iss</sub>		_	900	1170	pF
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		65	104	
Output capacitance		C <sub>oss</sub>			200		
Gate resistance			2.5	3.6	Ω		
Output capacitance Gate resistance Rise tim Turn-on Switching time Fall time Turn-off Total gate charge (gate-source plus gate-dra (Note 7)	Rise time	tr	$V_{GS} = 3.2 \text{ A}$ $V_{GS} = 3.2 \text{ A}$ O = 3.2  A G = 0  H  J G = 0  H  J G = 0  H  J $V_{DD} \approx 15 \text{ V}$ Duty $\leq 1\%$ , t <sub>w</sub> = 10 μs	_	2.3	_	
	Turn-on time	t <sub>on</sub>			7.0	_	
	Fall time	t <sub>f</sub>			9.2	_	ns
	Turn-off time	t <sub>off</sub>			28	_	
			$V_{DD} \approx 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 6.4 \text{ A}$ —		14	_	
(gate-source plus gate-drain) (Note 7)		Qg	$V_{DD}\approx 24~V,~V_{GS}=5~V,~I_D=6.4~A$		7.6	—	
Gate-source charge 1		Q <sub>gs1</sub>			2.4		nC
Gate-drain ("Miller") charge		Q <sub>gd</sub>	$V_{DD} \approx 24$ V, $V_{GS} = 10$ V, $I_D = 6.4$ A		2.5	_	1
Gate switch cha	Gate switch charge		1		3.4	_	

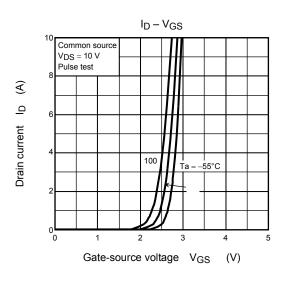
# Source–Drain Ratings and Characteristics (Ta = 25°C)

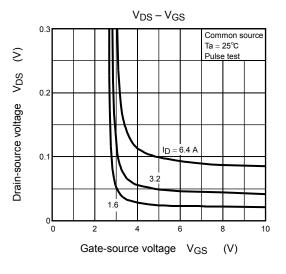
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I <sub>DRP</sub>	—	_	_	25.6	А
Forward voltage (diode)		V <sub>DSF</sub>	$I_{DR} = 6.4 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.2	V

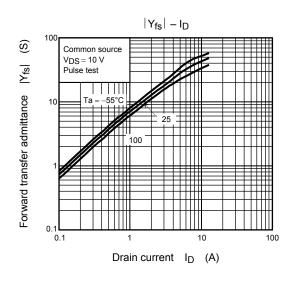
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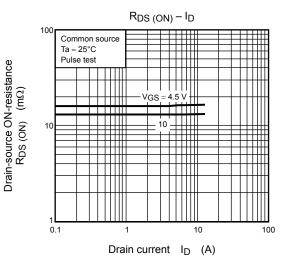




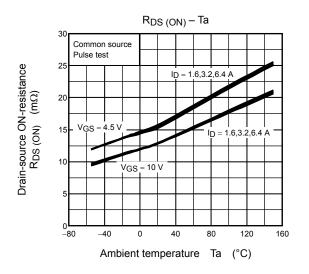


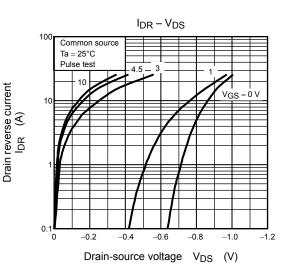


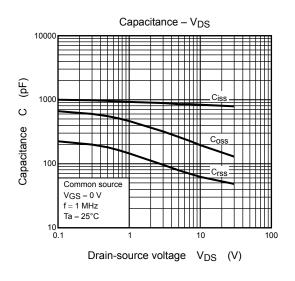


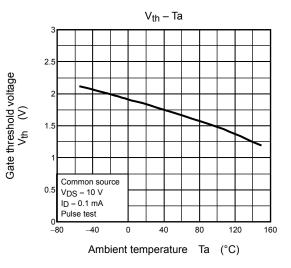


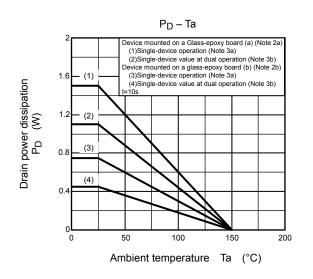
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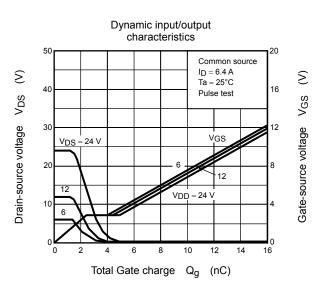


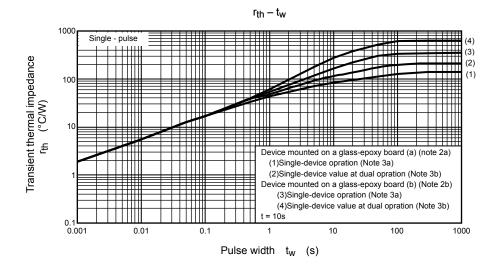


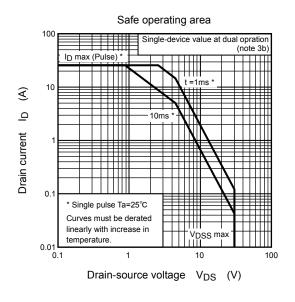












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